

In series

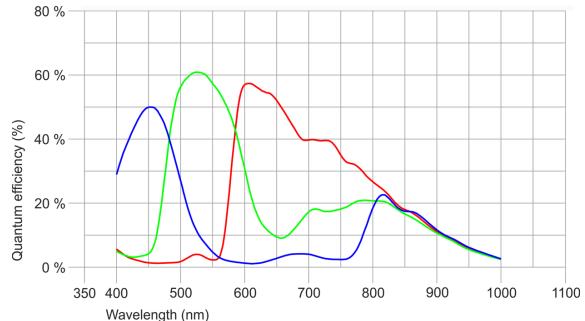
The model is in series and available for the long term.



Specification

Sensor

Sensor type	CMOS Color
Shutter	Global Shutter
Sensor characteristic	Linear
Readout mode	-
Pixel Class	9 MP
Resolution	8.92 Mpix
Resolution (h x v)	4104 x 2174 Pixel
Aspect ratio	17:9
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1"
Optical Size	14.159 mm x 7.500 mm
Optical sensor diagonal	16.02 mm 1"
Pixel size	3.45 µm
Manufacturer	Sony
Sensor Model	IMX267LQR-C
Gain (master/RGB)	24x/4x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 8
AOI image height / step width	4 / 2
AOI position grid (horizontal/vertical)	4 / 2
Binning horizontal	-
Binning vertical	-
Binning method	-
Binning factor	-
Decimation (subsampling) horizontal	same frame rate
Decimation (subsampling) vertical	increased frame rate
Decimation (subsampling) method	M/C automatic
Decimation (subsampling) factor	2_4x2_4



Model

Pixel clock range	99 MHz - 140 MHz
Frame rate freerun mode	12 fps
Frame rate trigger (continuous)	12 fps
Frame rate trigger (maximum)	12 fps
Exposure time (minimum - maximum)	0.047 ms - 1000 ms
Long exposure (maximum)	30000 ms
Power consumption	1.7 W - 3.1 W
Image memory	128 MB
Special features	IDS line scan mode Overlap trigger Sensor source gain

Ambient conditions

For PCB versions, refer to the separate hints in the respective documentation.

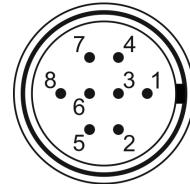
Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed device temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	GigE RJ45
I/O connector	8-pin Hirose connector (HR25-7TR-8PA(73))
Power supply	12 V - 24 V or PoE

Pin assignment I/O connector

1	Ground (GND)
2	Flash output with optocoupler (-)
3	General Purpose I/O (GPIO) 1
4	Trigger input with optocoupler (-)
5	Flash output with optocoupler (+)
6	General Purpose I/O (GPIO) 2
7	Trigger input with optocoupler (+)
8	Input power supply (VCC) 12-24 V DC

**Design**

Lens Mount	No mount
IP code	-
Dimensions H/W/L	31.5 mm x 40.0 mm x 30.0 mm
Mass	38 g
Housing material	-

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

Image Acquisition	Freerun	✓
	Software trigger	-
	Hardware trigger	✓
	Trigger controlled exposure	-
	Denoiser	-
	Long exposure	✓
	Line scan	✓

Subject to technical modifications (2026-01-15)

UI-5292SE-C Rev.4.2 (AB12268)

Flashing	Flashing	-
	PWM flashing	-
Image Adjustments	Auto exposure	-
	Auto gain	-
	Auto whitebalance	-
	Color correction	-
	Gamma	-
	LUT	-
	Mirror/flip	-
On-board Image Processing	Pixel formats	
	Region of interest	✓
	Decimation (FPGA)	-
	Decimation (Sensor)	(2,4)x(2,4)
	Binning (FPGA)	-
Others	Chunks	-
	Sequencer	-
	Firmware update	-
	1st supported firmware version	4.96.1